

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Chan Ho KWON</td> <td>09/27/2013</td> </tr> <tr> <td>So Young EOM</td> <td>09/27/2013</td> </tr> <tr> <td>Hong Lae KIM</td> <td>09/27/2013</td> </tr> </tbody> </table>		Name	Execution Date	Chan Ho KWON	09/27/2013	So Young EOM	09/27/2013	Hong Lae KIM	09/27/2013		
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<table border="1"> <tr> <td>Name:</td> <td>KANGWON NATIONAL UNIVERSITY-INDUSTRY COOPERATION FOUNDATION</td> </tr> <tr> <td>Street Address:</td> <td>1, Gangwondaehak-gil,</td> </tr> <tr> <td>City:</td> <td>Chuncheon-si, Gangwon-do</td> </tr> <tr> <td>State/Country:</td> <td>KOREA, REPUBLIC OF</td> </tr> <tr> <td>Postal Code:</td> <td>200-701</td> </tr> </table>		Name:	KANGWON NATIONAL UNIVERSITY-INDUSTRY COOPERATION FOUNDATION	Street Address:	1, Gangwondaehak-gil,	City:	Chuncheon-si, Gangwon-do	State/Country:	KOREA, REPUBLIC OF	Postal Code:	200-701
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PROPERTY NUMBERS Total: 1											
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CORRESPONDENCE DATA											
Fax Number: <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> Phone: 2126618000 Email: info@lmiplaw.com Correspondent Name: LUCAS & MERCANTI, LLP Address Line 1: 475 PARK AVENUE SOUTH Address Line 2: 15TH FLOOR Address Line 4: NEW YORK, NEW YORK 10016											
ATTORNEY DOCKET NUMBER:	428-1247										
NAME OF SUBMITTER:	Barbara Villani										
Signature:	/Barbara Villani/										

Date:

10/01/2013

Total Attachments: 2

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Docket No. 428-1247

ASSIGNMENT OF RIGHTS, TITLE AND INTEREST IN INVENTION

This is an assignment of the following rights, title and interest (check all that apply):

- ☒ *United States of America rights, title and interest in the invention*
☐ *Foreign rights, title and interest in the invention*
☐ *United States Patent Application Serial No.* 14/043,074
Date of Execution: *Date of Filing:* October 1, 2013
☐ *United States Provisional Patent Application Serial No.* _____
☐ *United States Patent No(s).* _____
☐ *International (PCT) Patent Application Serial No.* _____
☐ *Other (specify)* _____

Title of the Invention:

Preparation method of silver nano-structure for surface enhanced Raman scattering substrate and silver nano-structure thereby

Inventors (assignors):

<i>Name</i>	<i>Address</i>
KWON, Chan Ho	#105-205 Hyunjin Ever-vill 1-cha, Seoksa-dong, Chuncheon-si, Gangwon-do 200-776, Republic of Korea
EOM, So Young	157-46 Yaksa-dong, Chuncheon-si, Gangwon-do 200-120, Republic of Korea
KIM, Hong Lae	#2208-1602 Hyosung Baeksyeon Gayak Apt., 671, Hopyeong-dong, Namyangju-si, Gyeonggi-do 472-787, Republic of Korea

Assignee 1:

<i>Name</i>	<i>Address</i>
KANGWON NATIONAL UNIVERSITY-INDUSTRY COOPERATION FOUNDATION	1, Gangwondaehak-gil, Chuncheon-si, Gangwon-do 200-701, Republic of Korea

Whereas, we, the above-identified Inventors, have invented certain new and useful improvements in the invention identified above and described in the above-identified patent application(s) and /or patent(s) (hereinafter referred to as "invention");

And, whereas we desire to assign our above-identified rights, title and interest in the invention to the above-identified Assignee;

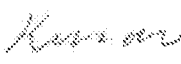
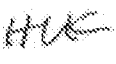
Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged;

We hereby assign, sell and transfer our above-identified rights, title and interest in said invention, said application(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all reissues and reexaminations thereof, which may be granted or have granted for said invention, and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, unto said Assignee;

And we hereby authorize and request the Commissioner of Patents and Trademarks to issue any United States Letters Patent which may issue for said invention to said Assignee, as assignee of the whole right, title and interest thereto;

And we further agree to sign and execute all necessary and lawful future documents, including applications for foreign patents, for filing divisions, continuations and continuation-in-part of said application for patent and/or for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the Assignee or its Designee(s) may from time to time require and prepare at its own expense.

Inventors' Signatures:

Name	Signature/ Date
KWON, Chan Ho	 September 27, 2013
EOM, So Young	 September 27, 2013
KIM, Hong Lac	 September 27, 2013